XC6367/XC6368 Series

ETR0401_004a

PWM Controlled, PWM/PFM Switchable Step-up DC/DC Controllers

☆GreenOperation-Compatible

■GENERAL DESCRIPTION

The XC6367/XC6368 series are multi-functional step-up DC/DC controllers which provide high efficiency outputs by using an externally connected transistor, coil, diode and capacitor.

Output voltage is selectable in 0.1V increments within a range of $1.5V \sim 6.5V$ (±2.5%). For output voltages outside this range, we recommend FB version, which has a 1.0V internal reference voltage. Using the FB version, the required output voltage can be set-up using 2 external resistors.

With a 300kHz oscillation frequency, the size of the external components can be reduced.

Control switches from PWM to PFM during light loads with the XC6368 (PWM/PFM switchable) and the series is highly efficient from light loads to large output currents.

Soft start time of XC6367/ XC6368A, B, and E series is internally set to 10ms and XC6367/68C, D, and F series regulate soft-start time by connecting resistors and capacitors externally.

During stand-by (CE pin "Low"), supply current is reduced to less than 0.5 µ A.

■ APPLICATIONS

•Electronic information organizers

- Palmtops
- •Cellular and portable phones
- Portable audio systems
- •Various multi-function power supplies

FEATURES

Input Voltage Range	: 0.9V ~ 10V
Operating Voltage Range	: 2.0V ~ 10V
Output voltage Range	: 1.5V ~ 6.5V (0.1V increments) (±2.5%)
Oscillation Frequency	: 300kHz, 100kHz (±15%)
	Custom products for 180kHz, 500kHz
Output Current	: More than 200mA (VIN=1.8V, VOUT=3.3V)
High Efficiency	: 84% (TYP.)
Stand-by capability	: I _{STB} =0.5 μ Α (MAX.)
Selection	: Soft-start set-up external
	Output voltage set-up internal (Vour)
	Output voltage set-up external (FB)
	PWM/PFM Control (XC6368)
Package	: SOT-25
Environmentally Friendly	: EU RoHS Compliant, Pb Free

■TYPICAL APPLICATION CIRCUIT



TYPICAL PERFORMANCE CHARACTERISTICS XC6368A333MR (300kHz,3.3V)



■PIN CONFIGURATION

XC6367/XC6368 series

XC6367/XC6368 series E, F types





SOT-25 (TOP VIEW)

PIN ASSIGNMENT

PIN NUMBER			
XC6367	/XC6368	PIN NAME	FUNCTION
A, B, C, D	E, F		
5	5	EXT	: External Transistor Connection
2	-	Vdd	: Supply Voltage Input
4	4	GND	: Ground
3	1	CE	: Chip Enable (C, D, F Types: Soft Start External Set-Up, Soft Start Capacitor Connected)
1	2	Vout (FB)	: Output Voltage Monitor (E, F Types: Output Voltage Monitor, Power Supply) (B, D Types: Output Voltage External Set-up)

PRODUCT CLASSIFICATION

Selection Guide



■ PRODUCT CLASSIFICATION (Continued)

Ordering Information

XC6367(12)3(4)5(6-7)(*1) PWM Control

<u>XC6368①②③④⑤⑥─⑦</u> ⁽¹⁾ PWM/PFM Switching Control					
DESIGNATOR	ITEM	SYMBOL	DESCRIPTION		
		А	VOUT type: VOUT internally set-up, Soft-start internally set-up		
		В	FB type: Vout externally set-up, Soft-start internally set-up		
	Type of DC/DC Convertor	С	Vout type: Vout internally set-up, Soft-start externally set-up		
\oplus	Type of DC/DC Converter	D	FB type: Vout externally set-up, Soft-start externally set-up		
		E	VOUT type: VOUT internally set-up, Soft-start internally set-up		
		F	Vout type: Vout internally set-up, Soft-start externally set-up		
23		15 ~ 65	Vour type: 3.0V output \rightarrow (2)=3, (3)=0		
	Output voltage	10	FB type (B, D types): 10 fixed \rightarrow (2)=1, (3)=0 fixed		
		3	300kHz		
	Oscillation Fraguency	1	100kHz		
4	Oscillation Frequency	2	180kHz (Custom)		
		5	500kHz (Custom)		
56-7	Package	MR	SOT-25 (3,000/Reel)		
(2)(6)-(7)	(Order Unit)	MR-G	SOT-25 (3,000/Reel)		

(*1) The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.

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■BLOCK DIAGRAMS

XC6367, XC6368 Series A, C, E, F types (VOUT)



 * Vout and Vdd of the E and F types should be connected internally.

XC6367, XC6368 Series B,D types (FB)



■ABSOLUTE MAXIMUM RATINGS

		30	Ta = 25°C
PARAMETER	SYMBOL	RATINGS	UNITS
VDD Pin Voltage	Vdd	-0.3 ~ +12.0	V
VOUT Pin Voltage	Vout	-0.3 ~ +12.0	V
FB Pin Voltage	Vfb	-0.3 ~ +12.0	V
CE Pin Voltage	VCE	-0.3 ~ +12.0	V
EXT Pin Voltage	Vext	-0.3 ~ VDD+0.3	V
EXT Pin Current	IEXT	±100	mA
Power Dissipation	Pd	150	mW
Operating Temperature Range	Topr	-30 ~ +80	°C
Storage Temperature Range	Tstg	-40 ~ +125	S

*Voltage is all ground standardized.

■ ELECTRICAL CHARACTERISTICS

XC6367A333MR, XC6368A33	3MR	Vou	лт=3.3V, I	FOSC=3	00kHz, Ta	=25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output Voltage	Vout		3.218	3.300	3.383	V
Supply Voltage (* 1)	Vdd		2.0	-	10.0	V
Maximum Input Voltage	Vin		10.0	-	-	V
Oscillation Start Voltage 1	Vst1	Tr: 2SD1628, IOUT=1.0mA	-	-	0.9	V
Oscillation Start Voltage 2	VST2	Vout=CE: Apply voltage	-	-	0.8	V
Oscillation Hold Voltage	Vhld	Tr: Use of a 2SX1628, IOUT=1.0mA	-	-	0.7	V
Supply Current 1	IDD1	Vout=CE=setting output voltage x 0.95	-	130	200	μA
Supply Current 2	IDD2	Vout=CE=setting output voltage + 0.5V	-	20	35	μA
Stand-by Current	ISTB	VOUT=setting output voltage x 0.95, CE=0V	-	-	0.5	μA
Oscillator Frequency	FOSC	Same as IDD1	255	300	345	kHz
Maximum Duty Ratio	MAXDTY	Same as IDD1	78	85	92	%
PFM Duty Ratio (* 3)	PFMDTY	Iout=0mA	15	25	35	%
CE "High" Voltage	Vсен	Vout=setting output voltage x0.95	0.65	-	-	V
CE "Low" Voltage	VCEL	Vout=setting output voltage x0.95	-	-	0.20	V
EXT "High" ON Resistance	Rexth	Same as IDD1, VEXT=VOUT-0.4V	-	29	43	Ω
EXT "Low" ON Resistance	Rextl	Same as IDD1, VEXT=0.4V	-	19	27	Ω
Efficiency (* 2)	EFFI		-	84	-	%
Soft-Start Time	Tss		5	10	20	msec

Conditions: Unless otherwise stated, connect VDD to VOUT; VIN=setting output voltage x 0.6, IOUT=130mA NOTE:

* 1: When taking VDD from another power source please ensure that VDD = 2.0V or more. Oscillation will occur with a value of VDD = 0.8V or more, but with a value of VDD = 2.0V or more, output voltage and oscillation frequency will be stable.

* 2: EFFI = {[(output voltage) x (output current)] ÷ [(input voltage) x (input current)] x 100

XC6367A503MR, XC6368A503MR

VOUT=5.0V, FOSC=300kHz,Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output Voltage	Vout		4875	5.000	5.125	V
Supply Voltage (* 1)	Vdd		2.0	-	10.0	V
Maximum Input Voltage	Vin		10.0	-	-	V
Oscillation Start Voltage 1	VST1	Tr: 2SD1628, IOUT=1.0mA	-	-	0.9	V
Oscillation Start Voltage 2	VST2	Vout=CE : Apply voltage	-	-	0.8	V
Oscillation Hold Voltage	Vhld	Tr: 2SD1628, IOUT=1.0mA	-	-	0.7	V
Supply Current 1	IDD1	Vout=CE=setting output voltage x 0.95	-	180	280	μA
Supply Current 2	IDD2	Vout=CE=setting output voltage + 0.5V	-	22	38	μA
Stand-by Current	Istb	VOUT=setting output voltage x 0.95, CE=0V	-	-	0.5	μA
Oscillation Frequency	FOSC	Same as IDD1	255	300	345	kHz
Maximum Duty Ratio	MAXDTY	Same as IDD1	78	85	92	%
PFM Duty Ratio (* 3)	PFMDTY	IOUT=0mA	15	25	35	%
CE "High" Voltage	VCEH	Vout=setting output voltage x0.95	0.65	-	-	V
CE "Low" Voltage	VCEL	Vout=setting output voltage x0.95	-	-	0.20	V
EXT "High" ON Resistance	Rexth	Same as IDD1, VEXT=VOUT-0.4V	-	20	29	Ω
EXT "Low" ON Resistance	Rextl	Same as IDD1, VEXT=0.4V	-	13	19	Ω
Efficiency (* 2)	EFFI		-	87	-	%
		Connect Rss and Css,				
Soft-Start Time	Tss	CE:0V→3.0V	5	10	20	msec
		(XC6367C/F and XC6368C/F series)				

Conditions: Unless otherwise specified, connect V_DD to V_OUT; V_IN=setting output voltage x 0.6, IOUT=200mA NOTE:

* 1: When taking VDD from another power source please ensure that VDD = 2.0V or more. Oscillation will occur with a value of VDD = 0.8V or more, but with a value of VDD = 2.0V or more, output voltage and oscillation frequency will be stable.

* 2: EFFI = {[(output voltage) x (output current)] ÷ [(input voltage) x (input current)] x 100

* 3: Applies to the XC6368 series only (duty ratio when control changes to PFM).

* 4: The values of supply voltage and NOTE *1 do not apply to XC6367E/F and XC6368E/F series. For XC6367E/F and XC6368E/F series, output voltage less than 2.0V cannot be set-up.

XC6367B103MR, XC6368B103MR

XC6367B103MR, XC6368B103M	R	N	/0UT=3.0V	, FOSC=	300kHz,	Ta=25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output Voltage	Vout		2.925	3.000	3.075	V
Supply Voltage (* 1)	Vdd		2.0	-	10.0	V
Maximum Input Voltage	Vin		10.0	-	-	V
Oscillation Start Voltage 1	Vst1	Tr: 2SD1628, IOUT=1.0mA	-	-	0.9	V
Oscillation Start Voltage 2	VST2	VDD=CE: Apply voltage, FB=0V	-	-	0.8	V
Oscillation Hold Voltage	Vhld	Tr: 2SD1628, IOUT=1.0mA	-	-	0.7	V
Supply Current 1	IDD1	VDD=CE=2.85V,FB=0V	-	120	190	μA
Supply Current 2	IDD2	VDD=CE=3.5V,FB=1.2V	-	20	34	μA
Stand-by Current	Istb	VDD=2.85V, CE=0V, FB=0V	-	-	0.5	μA
Oscillation Frequency	FOSC	Same as IDD1	255	300	345	kHz
Maximum Duty Ratio	MAXDTY	Same as IDD1	78	85	92	%
PFM Duty Ratio (* 3)	PFMDTY	IOUT=0mA	15	25	35	%
CE "High" Voltage	VCEH	VDD=2.85V,FB=0V	0.65	-	-	V
CE "Low" Voltage	VCEL	VDD=2.85V,FB=0V	-	-	0.20	V
EXT "High" ON Resistance	Rexth	Same as IDD1, VEXT=VDD-0.4V	-	32	47	Ω
EXT "Low" ON Resistance	Rextl	Same as IDD1, VEXT=0.4V	-	20	30	Ω
Efficiency (* 2)	EFFI		-	84	-	%
Soft-Start Time	Tss	Connect Rss and Css, CE:0V→3.0V (XC6367D/68D series) 5	10	20	msec

Conditions: Unless otherwise stated, VIN=1.8V, IOUT=120mA

External components : RFB1 = 400k Ω , RFB2 = 200k Ω , CFB = 47pF

NOTE:

* 1: When taking VDD from another power source please ensure that VDD = 2.0V or more. Oscillation will occur with a value of VDD = 0.8V or more, but with a value of VDD = 2.0V or more, output voltage and oscillation frequency will be stable.

* 2: EFFI = {[(output voltage) x (output current)] ÷ [(input voltage) x (input current)] x 100

XC6367A331MR, XC6368A331MR

VOUT=3.3V, FOSC=100kHz, Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output Voltage	Vout		3.218	3.300	3.383	V
Supply Voltage (* 1)	Vdd		2.0	-	10.0	V
Maximum Input Voltage	Vin		10.0	-	-	V
Oscillation Start Voltage 1	Vst1	Tr: 2SD1628, IOUT=1.0mA	-	-	0.9	V
Oscillation Start Voltage 2	VST2	Vout=CE: Apply voltage	-	-	0.8	V
Oscillation Hold Voltage	Vhld	Tr: 2SD1628, IOUT=1.0mA	-	-	0.7	V
Supply Current 1	IDD1	VOUT=CE=setting output voltage x 0.95	-	50	100	μA
Supply Current 2	IDD2	VOUT=CE=setting output voltage + 0.5V	-	11	20	μA
Stand-by Current	ISTB	VOUT=setting output voltage x 0.95, CE=0V	-	-	0.5	μA
Oscillation Frequency	FOSC	Same as IDD1	85	100	115	kHz
Maximum Duty Ratio	MAXDTY	Same as IDD1	78	85	92	%
PFM Duty Ratio (* 3)	PFMDTY	Iout=0mA	15	25	35	%
CE "High" Voltage	VCEH	Vout=setting output voltage x0.95	0.65	-	-	V
CE "Low" Voltage	VCEL	Vout=setting output voltage x0.95	-	-	0.20	V
EXT "High" ON Resistance	Rexth	Same as IDD1, VEXT=VOUT-0.4V	-	29	43	Ω
EXT "Low" ON Resistance	REXTL	Same as IDD1, VEXT=0.4V	-	19	27	Ω
Efficiency (* 2)	EFFI		-	84	-	%
Soft-Start Time	Tss		5	10	20	msec

Conditions: Unless otherwise stated, connect VDD to VOUT; VIN=setting output voltage x 0.6, IOUT=130mA NOTE:

* 1: When taking VDD from another power source please ensure that VDD = 2.0V or more. Oscillation will occur with a value of VDD = 0.8V or more, but with a value of VDD = 2.0V or more, output voltage and oscillation frequency will be stable.

* 2: EFFI = {[(output voltage) x (output current)] ÷ [(input voltage) x (input current)] x 100

XC6367A501MR, XC6368A501MR

VOUT=5.0V, FOSC=100kHz, Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output Voltage	Vout		4875	5.000	5.125	V
Supply Voltage (* 1)	Vdd		2.0	-	10.0	V
Maximum Input Voltage	Vin		10.0	-	-	V
Oscillation Start Voltage 1	VST1	Tr: 2SD1628, IOUT=1.0mA	-	-	0.9	V
Oscillation Start Voltage 2	VST2	Vout=CE: Apply voltage	-	-	0.8	V
Oscillation Hold Voltage	Vhld	Tr: 2SX1628, IOUT=1.0mA	-	-	0.7	V
Supply Current 1	IDD1	Vout=CE=setting output voltage x 0.95	-	70	120	μA
Supply Current 2	IDD2	Vout=CE=setting output voltage + 0.5V	-	11	22	μA
Stand-by Current	Istb	VOUT=setting output voltage x 0.95, CE=0V	-	-	0.5	μA
Oscillation Frequency	FOSC	Same as IDD1	85	100	115	kHz
Maximum Duty Ratio	MAXDTY	Same as IDD1	78	85	92	%
PFM Duty Ratio (* 3)	PFMDTY	Iout=0mA	15	25	35	%
CE "High" Voltage	VCEH	Vout=setting output voltage x0.95	0.65	-	-	V
CE "Low" Voltage	VCEL	Vout=setting output voltage x0.95	-	-	0.20	V
EXT "High" ON Resistance	Rexth	Same as IDD1, VEXT=VOUT-0.4V	-	20	29	Ω
EXT "Low" ON Resistance	Rextl	Same as IDD1, VEXT=0.4V	-	13	19	Ω
Efficiency (* 2)	EFFI		-	87	-	%
Soft-Start Time	Tss		5	10	20	msec

Conditions: Unless otherwise stated, connect VDD to VOUT; VIN=setting output voltage x 0.6, IOUT=200mA NOTE:

* 1: When taking VDD from another power source please ensure that VDD = 2.0V or more. Oscillation will occur with a value of VDD = 0.8V or more, but with a value of VDD = 2.0V or more, output voltage and oscillation frequency will be stable.

* 2: EFFI = {[(output voltage) x (output current)] ÷ [(input voltage) x (input current)] x 100

XC6367B101MR, XC6368B101MR

VOUT=3.0V, FOSC=100kHz, Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output Voltage	Vout		2.925	3.000	3.075	V
Supply Voltage (* 1)	Vdd		2.0	-	10.0	V
Maximum Input Voltage	Vin		10.0	-	-	V
Oscillation Start Voltage 1	VST1	Tr: 2SD1628, IOUT=1.0mA	-	-	0.9	V
Oscillation Start Voltage 2	VST2	VDD=CE: Apply voltage, FB=0V	-	-	0.8	V
Oscillation Hold Voltage	Vhld	Tr: 2SD1628, IOUT=1.0mA	-	-	0.7	V
Supply Current 1	IDD1	VDD=CE=2.85V, FB=0V	-	50	90	μA
Supply Current 2	IDD2	VDD=CE=3.5V, FB=1.2V	-	11	20	μA
Stand-by Current	Istb	VDD=2.85V, CE=0V, FB=0V	-	-	0.5	μA
Oscillation Frequency	FOSC	Same as IDD1	85	100	115	kHz
Maximum Duty Ratio	MAXDTY	Same as IDD1	78	85	92	%
PFM Duty Ratio (*3)	PFMDTY	IOUT=0mA	15	25	35	%
CE "High" Voltage	VCEH	VDD =2.85V,FB=0V	0.65	-	-	V
CE "Low" Voltage	VCEL	VDD =2.85V,FB=0V	-	-	0.20	V
EXT "High" ON Resistance	Rexth	Same as IDD1, VEXT=VDD-0.4V	-	32	47	Ω
EXT "Low" ON Resistance	Rextl	Same as IDD1, VEXT=0.4V	-	20	30	Ω
Efficiency (* 2)	EFFI		-	84	-	%
Soft-Start Time	Tss		5	10	20	msec

Conditions: Unless otherwise stated, VIN=1.8V, IOUT=120mA

External components : RFB1 = $400k\Omega$, RFB2 = $200k\Omega$, CFB = 47pF

NOTE:

* 1: When taking VDD from another power source please ensure that VDD = 2.0V or more. Oscillation will occur with a value of VDD = 0.8V or more, but with a value of VDD = 2.0V or more, output voltage and oscillation frequency will be stable.

* 2: EFFI = {[(output voltage) x (output current)] ÷ [(input voltage) x (input current)] x 100

■TEST CIRCUITS

Circuit 1. XC6367A, XC6368A



Circuit 2. XC6367B, XC6368B



Circuit 3. XC6367C, XC6368C



Circuit 4. XC6367D, XC6368D



Circuit 5. XC6367E, XC6368E







Circuit 7. XC6367A, XC6368A (NPN Transistor)



Circuit 8. XC6367B, XC6368B (NPN Transistor)



Circuit 9. XC6367C, XC6368C (NPN Transistor)



Circuit 10. XC6367D, XC6368D (NPN Transistor)



Circuit 11. XC6367E, XC6368E (NPN Transistor)



Circuit 12. XC6367F, XC6368F (NPN Transistor)



External Components

Tr	: XP161A1355PR (N-ch Power MOSFET, TOREX)
	As the breakdown voltage of XP161A1355PR is 8V, take care
	with the power supply voltage. With output voltages over 6V,
	use the XP161A1265PR with a breakdown voltage of 12V.
	VST1 : XP161A1355PR = 1.2V (MAX.)
	XP161A1265PR = 1.5V (MAX.)
L	: 22 µ H (CR54, SUMIDA FOSC=300kHz)
	47 μ Η (CR75, SUMIDA FOSC=100, 180kHz)
	10 μ H (CR54, SUMIDA FOSC=500kHz)
SD	: MA2Q735 (Schottky Diode, MATSUSHITA)
CIN	: 16V, 220 μ F (Aluminium Electrolytic Capacitor)
CL	: 16V, 47 μ F + 47 μ F (Tantalum capacitor, NICHICON MCE)

NPN Tr type:

Tr	: 2SD1628 (SANYO)
Rb	: 500 Ω (Adjust according to load and Tr. hFE levels)
Cb	: 2200pF (Ceramic Type)

Set up so that $CB \le 1 \div (2 \pi x RB \times FOSC \times 0.7)$

C, D, F type (soft-start externally set-up):

Css	: 0.1 μ F (Ceramic Capacitor)
Rss	: 470k Ω (C, F Type), 220k Ω (D Type)

B, D type (FB versions)

Rfb	: Set up so that $R_{FB1} \div R_{FB2} = V_{OUT} - 1$ (VOUT = setting output voltage),
	Please use with RFB1 + RFB2 $\leq 2M\Omega$
Cfb	: Set up so that $fzfb = 1 \div (2 \times \pi x CFB \times RFB1)$ is within the
	0.1 to 20kHz range (10kHz conventional)
	Adjustments necessary in respect of L, CL.
e.g	Vout = 3.0V
	$RFB1 = 400 k\Omega,RFB2 = 200 k\Omega,CFB = 47pF$

For using MOSFET, We recommend using TOREX MOSFETs, which has a gate protection diode built-in.

GATE PROTECTION DIODE BUILT-IN MOSFET	Rds (ON)
XP161A1355PR	0.15Ω@ Vgs=1.5V
XP161A1265PR	0.095Ω@ Vgs=2.5V

XC6367/XC6368 Series

■NOTES ON USE

- 1. Take ample care to ensure that none of the IC's, nor the external component's, absolute maximum ratings are exceeded.
- 2. Be extremely careful when selecting parts and do not limit your reference to the specifications and characteristics for the DC/DC converter alone. The IC also depends, to a great extent, upon the external components.
- 3. Arrange the peripherals in the environs of the IC. In order to reduce wiring impedance, use short, thick wires. In particular, wire the load capacitor as close as possible and strengthen the ground wiring sufficiently.
- 4. Ground current during switching may cause the IC's operations to become unstable due to changes in ground voltage, so please strengthen the IC's GND pin surroundings.

External Components

1.Setting soft-start time

In order to lengthen soft-start time we recommend that you use the C or D types of the series which have soft start time externally set-up.

Soft-start time (Tss) is between MIN & MAX, as indicated in the graphs below, so please select soft-start capacitor value (Css) to suit your application.



2. RFB1, CFB set up

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fzfb = 1 \div (2\pi x CFB \times RFB1)
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In order to achieve a value for fzfb within the range of 0.1kHz to 20kHz, we recommend that values for RFB1 & CFB are selected from the area indicated within the lines of fzfb = 0.1kHz and fzfb = 20 kHz as shown on the graph below. Please select combinations of values as close to the fzfb = 10kHz line as possible.



■TYPICAL PERFORMANCE CHARACTERISTICS

(1) Output Voltage vs. Output Current



XC6368A333MR (300kHz,3.3V)





 $\langle \text{External component} \rangle$ CIN=220 μ F (Electrolytic capacitor)



XC6368A333MR (300kHz,3.3V)





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(1) Output Voltage vs. Output Current (Continued)











(External component) CIN=220 µ F (Electrolytic capacitor)

(2) Efficiency vs. Output Current







 $\langle \text{External component} \rangle$ CIN=220 μ F (Electrolytic capacitor)

XC6368A503MR (300kHz,5.0V) L=22 µ H(CR54), CL=94 µ F(Tantalum) SD:MA737, Tr:XP161A1265P 100 4.0V 80 Efficiency:EFFI (%) 1 _ 3.0V 1.8V 60 40 VIN=0.9V 1.2V 1.5\ 20 0 0.1 1 10 100 1000 Output Current:IOUT (mA)

XC6368A333MR (300kHz,3.3V)





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(2) Efficiency vs. Output Current (Continued)



XC6368B103MR (300kHz,3.3V) L=22 µ H(CR54), CL=94 µ F(Tantalum) SD:MA737, Tr:XP161A1265P 100 2.7V 80 Efficiency:EFFI (%) 60 40 VIN=0.9V 1.2V 1.5V 1.8V 20 0 10 100 1000 0.1 1 Output Current: IOUT (mA)

L=22 μ H(CR54), CL=94 μ F(Tantalum) SD:MA737, Tr:XP161A1355P 100 2.7 80 Efficiency:EFFI (%) 60 40 VIN=0.9V 1.2V 1.5V 1.8V 20 0 10 1000 0.1 1 100 Output Current:IOUT (mA)

XC6368B102MR (180kHz,3.3V)



 $\langle \text{External component} \rangle$ CIN=220 μ F (Electrolytic capacitor)

(3) Ripple Voltage vs. Output Current





L=10 µ H(CR54), CL=94 µ F(Tantalum) SD:MA737, Tr:XP161A1355P















(3) Ripple Voltage vs. Output Current (Continued)



(4) Output Voltage vs. Ambient Temperature



(6) Supply Current 2 vs. Ambient Temperature



(8) EXT "H" On Resistance vs. Ambient Temperature



XC6368A333MR (300kHz,3.3V)

(5) Supply Current 1 vs. Ambient Temperature



(7) Stand-by Current vs. Ambient Temperature



XC6368A333MR (300kHz,3.3V)

(9) EXT "L" On Resistance vs. Ambient Temperature

VDD=VOUT=3.135V 50 40 30 20

EXT" L" ON Resistance:REXTL (Ω)

10

0

-40

-20

0

20

Ambient Temperature:Ta (°C)

40

60

80



XC6368A333MR (300kHz,3.3V)

(10) Oscillation Frequency vs. Ambient Temperature

(11) Maximum Duty Ratio vs. Ambient Temperature



(12) PFM Duty Ratio vs. Ambient Temperature

XC6368A333MR (300kHz,3.3V)



(14) Operation Start Voltage vs. Ambient Temperature





(13) Efficiency vs. Ambient Temperature

XC6368A333MR (300kHz,3.3V) L=22 µ H(CR54), CL=94 µ F(Tantalum) SD:MA737, Tr:XP161A1355P 100 80 Efficiency:EFFI (%) 60 40 20 . VIN=1.98V IOUT=130mA 0 -40 -20 0 20 40 60 80 Ambient Temperature: Ta (°C)

(15) Operation Hold Voltage vs. Ambient Temperature



XC6368B103MR (300kHz,2.8V)

(16) Oscillation Start Voltage vs. Ambient Temperature







(17) Soft-Start Time vs. Ambient Temperature

XC6368A503MR (300kHz,5.0V)



(19) CE "H" Voltage vs. Ambient Temperature



XC6368A333MR (300kHz,3.3V)





XC6368A333MR (300kHz,3.3V) VIN=1.98V, IOUT=100mA→100 µ A 500 3.5 Output Voltage Output Current: lour (mA) 400 3.4 3.3 300 3.2 200 100mA 3.1 100 Output Current

Time (50msec/div)

100 µ A

3.0











XC6368A333MR (300kHz,3.3V) VIN=1.98V, IOUT=10mA→100mA 500 3.4 Output Voltage (mA) Output Voltage:Vour (V) 3.3 400 Output Current:IoUT 3.2 300 3.1 200 Output Current 100mA 3.0 100 10mA 2.9 n Time (1.0msec/div)

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■ PACKAGING INFORMATION

•SOT-25





■MARKING RULE

•XC6367/6368 Series



1 represents product series

MARK	PRODUCT SERIES	MARK	PRODUCT SERIES
<u>A</u>	XC6367A	<u>K</u>	XC6368A
<u>B</u>	XC6367B	L	XC6368B
C	XC6367C	M	XC6368C
D	XC6367D	<u>N</u>	XC6368D
<u>E</u>	XC6367E	<u>P</u>	XC6368E
<u> </u>	XC6367F	<u>R</u>	XC6368F

SOT-25 (TOP VIEW)

2 represents integer of output voltage and oscillation frequency

	OSCILLATION FREQUENCY (kHz)			
OUTFUT VOLIAGE (V)	100	180	300	500
1	В	1	1	В
2	С	2	2	С
3	D	3	3	D
4	E	4	4	E
5	F	5	5	F
6	Н	6	6	Н
FOR CUSTOM PRODUCT	S			

③ represents decimal number of output voltage and oscillation frequency

	OSCILLATION FREQUENCY (kHz)			
OUTPUT VOLIAGE (V)	100	180	300	500
0	0	0	А	А
1	1	1	В	В
2	2	2	С	С
3	3	3	D	D
4	4	4	Ш	E
5	5	5	F	F
6	6	6	Н	Н
7	7	7	К	К
8	8	8	L	L
9	9	9	М	М

④ represents production lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)

XC6367/XC6368 Series

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